

Docket No.: TESSERA 3.3-018 CONT CONT II DIVCONTCON (PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Letters Patent of: Khandros et al.

Patent No.: 7,198,969

Issued: April 3, 2007

For: SEMICONDUCTOR CHIP ASSEMBLIES,

METHODS OF MAKING SAME AND

COMPONENTS FOR SAME

Certificate of Correction Branch Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450



Colc

## REQUEST FOR CERTIFICATE OF CORRECTION PURSUANT TO 37 C.F.R. § 1.323

Dear Sir:

Enclosed herewith is a Certificate of Correction with respect to the above-identified U.S. Patent. You are hereby authorized to charge Deposit Account No. 12-1095 in the amount of \$100 to cover the required fee for filing a Certificate of Correction under § 1.323.

These errors were inadvertent, occurred in good faith and do not involve any changes which constitute new matter.

We look forward to early return of the Certificate of Correction duly certified.

Dated: January 22, 2008

Respectfully submitted,

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01/28/2008 NNGUYEN2 00000045 121095 7198969 01 FC:1811 100.00 DA Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. (Also Form PTO-1050)

## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

Page \_1\_ of \_1\_

PATENT NO.

7,198,969

APPLICATION NO.

09/656,690

**ISSUE DATE** 

April 3, 2007

INVENTOR(S)

Igor Y. Khandros and Thomas H. DiStefano

It is certified that an error appears or errors appear in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the face page of Patent No. 7,198,969, under (75) Inventors, "Distefano" should read -- DiStefano -- .

Column 2, line 7, "between chips" should read -- between chips, -- .

Column 3, line 64, "overly one" should read -- overlie one -- .
Column 4, line 27, "provides method" should read -- provides a method -- .

Column 5, line 67, "overly only" should read -- overlie only -- .

Column 7, line 12, "overly the" should read -- overlie the -- .

Column 8, line 32, "may be made" should read -- may be made. -- .

Column 8, line 33, "instance by wire" should read -- instance, by wire -- .

Column 8, line 67, "made for example" should read -- made, for example, --.

Column 11, line 50, "interposer may" should read -- interposer may be -- .

Column 13, line 31, "overly the" should read -- overlie the -- .

Column 17, line 6, "Alternatively," should read -- Alternatively, as -- .

Column 18, line 12, "constitute a" should read -- constitute an -- .

Column 22, line 15, "arrangement, includes" should read -- arrangement includes --

Column 26, line 29, "motion of is middle" should read -- motion of middle -- . Column 28, line 32, "flap extends" should read -- flap extend -- . Column 28, line 63, "and may be" should read -- may be -- . Column 31, line 3, "count" should read -- count, -- . Column 35, line 65, "interpose using" should read -- interposer using -- . Column 38, line 30, "interpose using" should read -- interposer using -- .